	Applican	t Initiated l	Interview Req	uest Form	<u>.</u>		
Application No.: 10/582,673 Examiner: A. KWON Art Unit:					Toshiyuki INAGAKI atus of Application: Non-Final		
Tentative Participa (1) Patrick Muffo	nts:	(2)	Examiner Kwon		11-	_	
(3)		(4)				- A	
Proposed Date of I	nterview: <u>June 15, 2</u>	010	Proposed Time:	10:30	(A	M/PM) M	
Type of Interview I	Requested: (2) 🔀 Per:	sonal (3) 🗌 Video Conf	егепсе			
Exhibit To Be Show	vn or Demonstrated:	☐ YES		⊠ NO	<u>.</u>		
		Issues To	Be Discussed	<u> </u>	_	<u>-</u>	
Issues (Rej., Obj., etc)	Claims/ Fig. #s	Applied Re	ferencc(s)	Discussed	Agreed	Not Agreed	
Obj	<u>27</u>	N/A					
§112, 2 nd paragraph	27-39	N/A		_			
§103(a)	27-30 and 35- 38		l. (U.S. Patent No and Araldite Data Sheet				
Schmid and A	of Arguments to be Pr raldite do not teach Pa is used to form e	ı "an adhesiv	e having the Yost adhesive laye	oung's modulus or and the seco	s within a nd adhesi	range of 30 ve layer."	
<u>NOTE</u> : This form should be	conducted on the above completed by applican	nt and submitted	to the examiner in	submit a written	record of thi	is interview.	
	nt is advised to file a state	. <u>-</u>		xaminer/SPE Sig	· <u>-</u> ,		